

Features

- N-Channel
30V/5.6A,
 $R_{DS(ON)} = 15m\Omega$ (Typ.) @ $V_{GS}=10V$
 $R_{DS(ON)} = 23m\Omega$ (Typ.) @ $V_{GS}=4.5V$
- P-Channel
-30V/-3.9A,
 $R_{DS(ON)} = 36m\Omega$ (Typ.) @ $V_{GS}=-10V$
 $R_{DS(ON)} = 50m\Omega$ (Typ.) @ $V_{GS}=-4.5V$
- Very low on-resistance
- Fast Switching

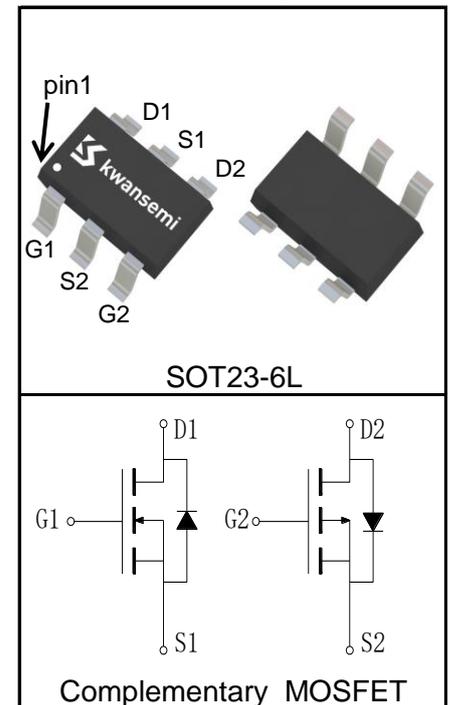
Applications

- BLDC Motor Driver



Halogen-Free

Pin Description



Absolute Maximum Ratings

Symbol	Parameter		N-Channel	P-Channel	Unit
Common Ratings ($T_A=25^\circ\text{C}$ Unless Otherwise Noted)					
V_{DSS}	Drain-Source Voltage		30	-30	V
V_{GSS}	Gate-Source Voltage		± 20	± 20	
T_{Jmax}	Maximum Junction Temperature		150	150	$^\circ\text{C}$
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to 150	-55 to 150	$^\circ\text{C}$
I_S	Diode Continuous Forward Current	$T_A=25^\circ\text{C}$	1.2	-1.1	A
Mounted on Large Heat Sink					
$I_{DP}^{①}$	Pulse Drain Current	$T_A=25^\circ\text{C}$	22	-15	A
$I_D^{②}$	Continuous Drain Current ($V_{GS}=\pm 10V$)	$T_A=25^\circ\text{C}$	5.6	-3.9	A
		$T_A=70^\circ\text{C}$	4.4	-3.1	
P_D	Maximum Power Dissipation	$T_A=25^\circ\text{C}$	1	1	W
		$T_A=70^\circ\text{C}$	0.64	0.64	
$R_{\theta JL}$	Thermal Resistance-Junction to Lead		80	80	$^\circ\text{C/W}$
$R_{\theta JA}^{③}$	Thermal Resistance-Junction to Ambient		125	125	$^\circ\text{C/W}$
Drain-Source Avalanche Ratings					
$E_{AS}^{④}$	Avalanche Energy, Single Pulsed		20	25	mJ

Electrical Characteristics ($T_A=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Condition	Rating			Unit	
			Min.	Typ.	Max.		
Static Characteristics							
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_{DS}=250\mu A$	N	30		V	
		$V_{GS}=0V, I_{DS}=-250\mu A$	P	-30			
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=30V, V_{GS}=0V$	N		1	μA	
		$T_J=125^\circ\text{C}$			30		
		$V_{DS}=-30V, V_{GS}=0V$	P		-1		
		$T_J=125^\circ\text{C}$			-30		
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=250\mu A$	N	1.1	1.5	2.3	V
		$V_{DS}=V_{GS}, I_{DS}=-250\mu A$	P	-1.1	-1.5	-2.3	
I_{GSS}	Gate Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	N			± 100	nA
		$V_{GS}=\pm 20V, V_{DS}=0V$	P			± 100	
$R_{DS(on)}^{(5)}$	Drain-Source On-state Resistance	$V_{GS}=10V, I_{DS}=3A$	N		15	20	m Ω
		$V_{GS}=-10V, I_{DS}=-3A$	P		36	45	
		$V_{GS}=4.5V, I_{DS}=2A$	N		23	30	
		$V_{GS}=-4.5V, I_{DS}=-2A$	P		50	65	
Diode Characteristics							
$V_{SD}^{(5)}$	Diode Forward Voltage	$I_{SD}=3A, V_{GS}=0V$	N		0.82	1.2	V
		$I_{SD}=-3A, V_{GS}=0V$	P		-0.85	-1.2	
t_{rr}	Reverse Recovery Time	N-Channel $I_{SD}=3A, di_{SD}/dt=100A/\mu s$	N		15		ns
			P		17		
Q_{rr}	Reverse Recovery Charge	P-Channel $I_{SD}=-3A, di_{SD}/dt=-100A/\mu s$	N		12		nC
			P		8		
Dynamic Characteristics⁽⁶⁾							
R_G	Gate Resistance	$V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$	N		3.2		Ω
			P		9		
C_{iss}	Input Capacitance	N-Channel $V_{GS}=0V, V_{DS}=15V,$ Frequency=1.0MHz	N		480		pF
			P		635		
C_{oss}	Output Capacitance	P-Channel $V_{GS}=0V, V_{DS}=-15V,$ Frequency=1.0MHz	N		65		
			P		70		
C_{rss}	Reverse Transfer Capacitance		N		55		
			P		65		

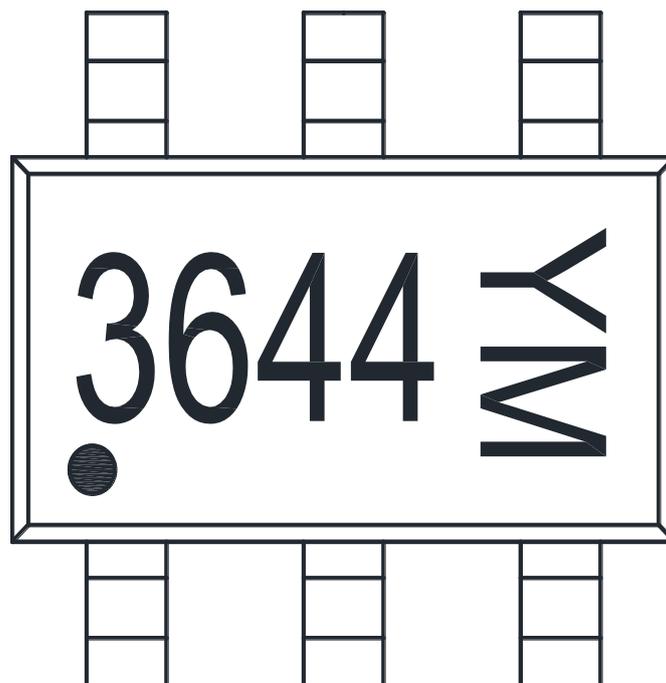
Electrical Characteristics ($T_A=25^{\circ}\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Condition	Rating			Unit	
			Min.	Typ.	Max.		
Dynamic Characteristics ^⑥							
$t_{d(ON)}$	Turn-on Delay Time	N-Channel $V_{DD}=15\text{V}$, $I_{DS}=3\text{A}$, $V_{GEN}=10\text{V}$, $R_G=3\Omega$ P-Channel $V_{DD}=-15\text{V}$, $I_{DS}=-3\text{A}$, $V_{GEN}=-10\text{V}$, $R_G=3\Omega$	N		13		ns
			P		10		
t_r	Turn-on Rise Time		N		11		
			P		7		
$t_{d(OFF)}$	Turn-off Delay Time		N		27		
			P		23		
t_f	Turn-off Fall Time	N		16			
		P		9			
Gate Charge Characteristics ^⑥							
Q_g	Total Gate Charge	N-Channel $V_{DS}=15\text{V}$, $V_{GS}=10\text{V}$, $I_{DS}=3\text{A}$ P-Channel $V_{DS}=-15\text{V}$, $V_{GS}=-10\text{V}$, $I_{DS}=-3\text{A}$	N		9.8		nC
			P		10.4		
Q_{gs}	Gate-Source Charge		N		1.3		
			P		1.5		
Q_{gd}	Gate-Drain Charge		N		2.1		
			P		2.3		

- Notes:
- ① Pulse width limited by safe operating area.
 - ② Calculated continuous current based on maximum allowable junction temperature.
 - ③ When mounted on 1 inch square copper board, $t \leq 10\text{sec}$. The value in any given application depends on the user's specific board design.
 - ④ Limited by T_{Jmax} . Starting $T_J = 25^{\circ}\text{C}$, N Channel: $I_{ASmax} = 9\text{A}$, $L=0.5\text{mH}$, $V_{DD} = 20\text{V}$, $R_G = 25\Omega$, $V_{GS}=10\text{V}$, Part not recommended for use above this value. P-Chanel: $I_{ASmax} = -10\text{A}$, $L=0.5\text{mH}$, $V_{DD} = -20\text{V}$, $R_G = 25\Omega$, $V_{GS}=-10\text{V}$, Part not recommended for use above this value.
 - ⑤ Pulse test; Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
 - ⑥ Guaranteed by design, not subject to production testing.

Ordering and Marking Information

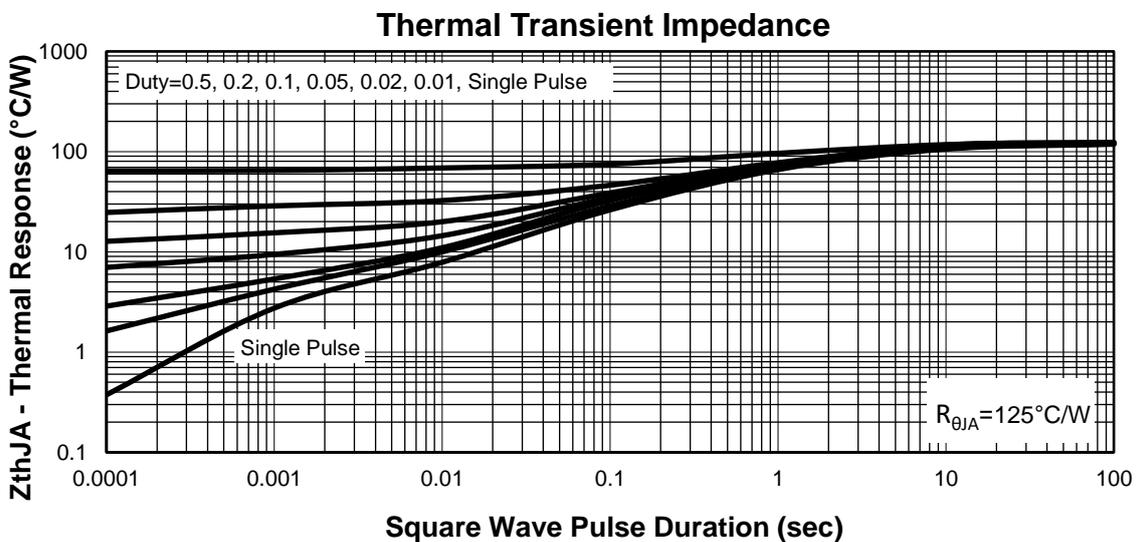
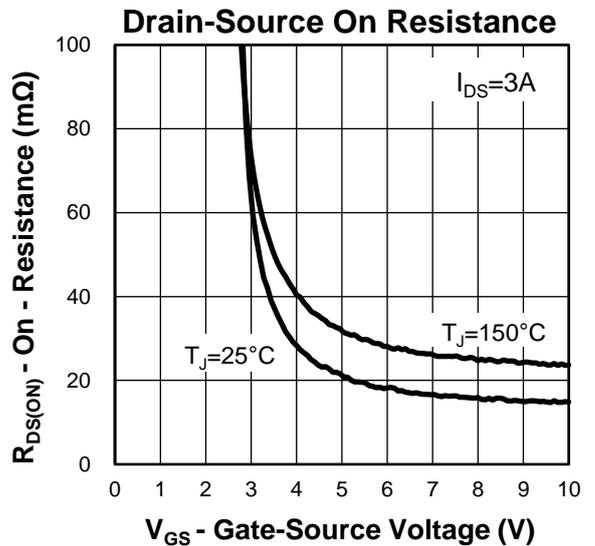
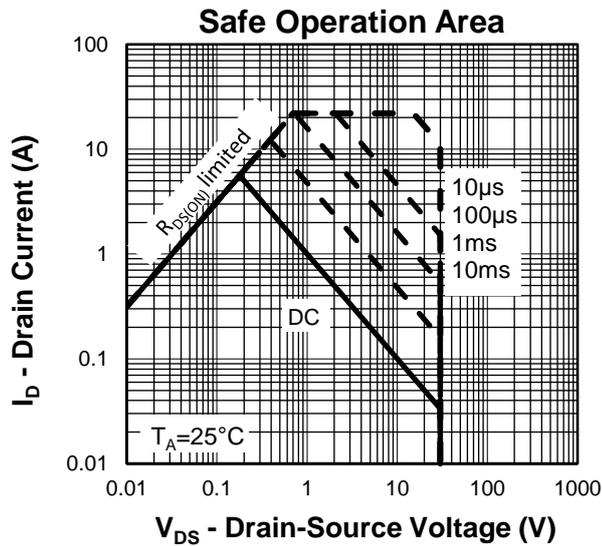
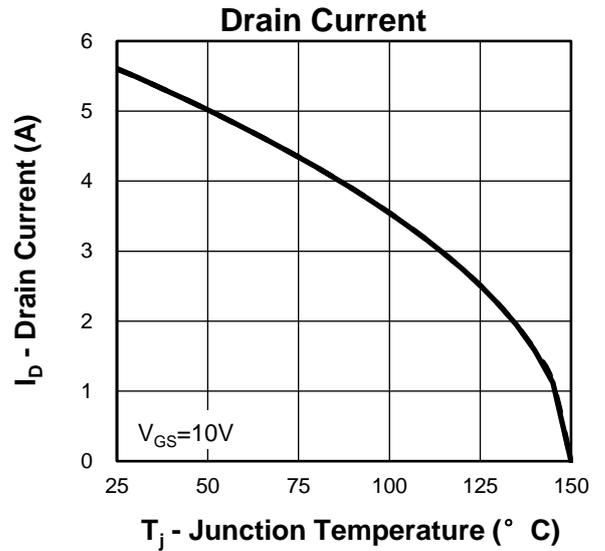
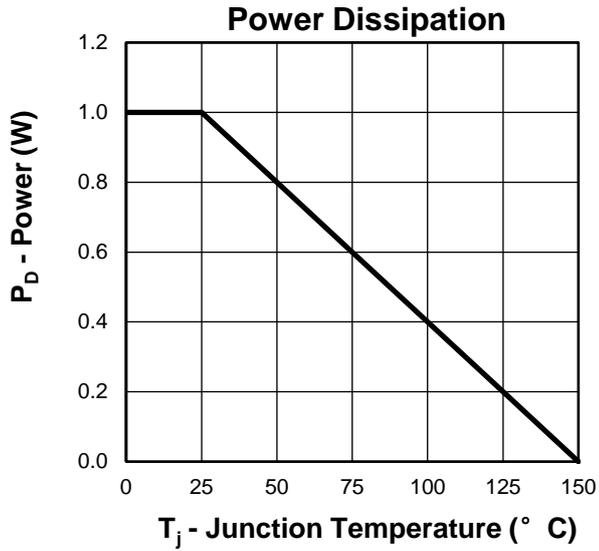
Device	Package	Packaging	Quantity	Reel Size	Tape width
KS3644EA6	SOT23-6L	Tape&Reel	3000	7"	8mm



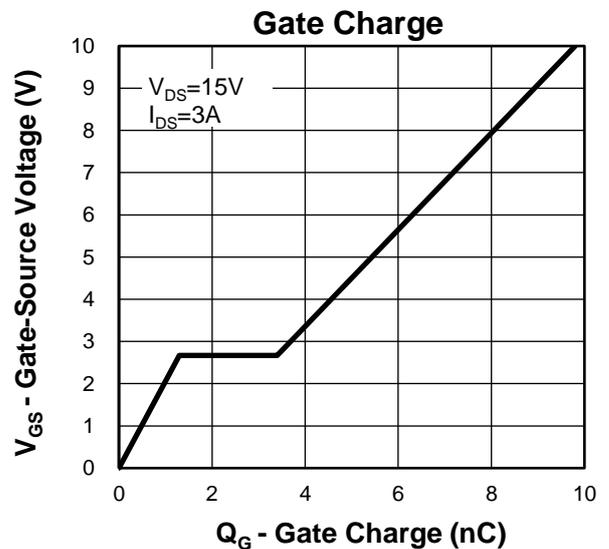
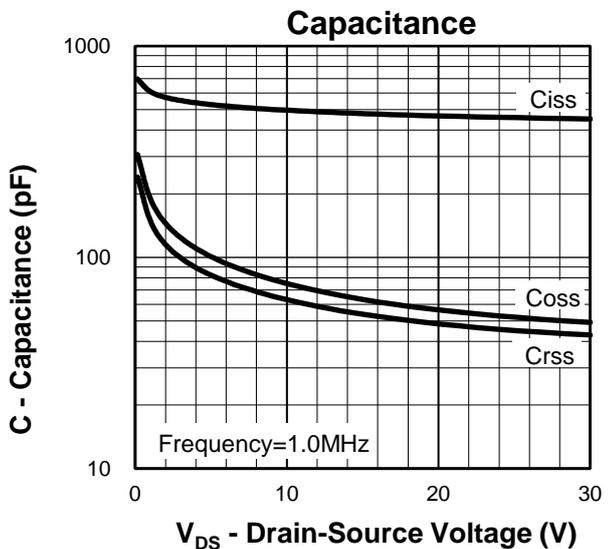
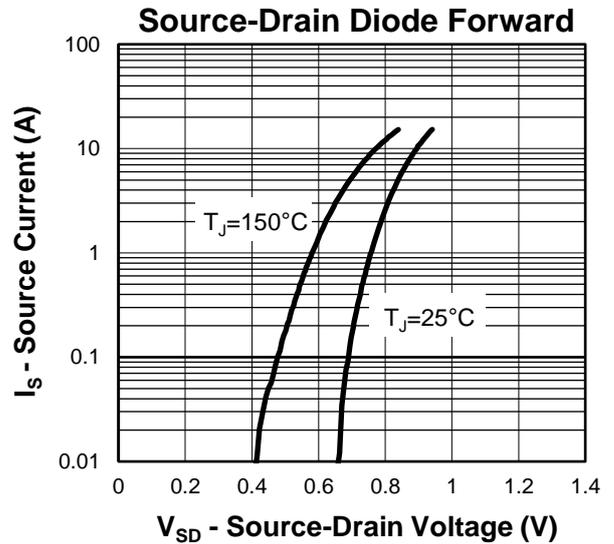
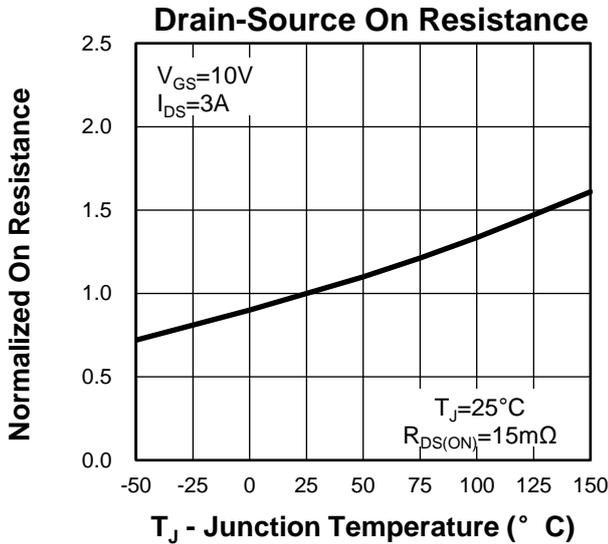
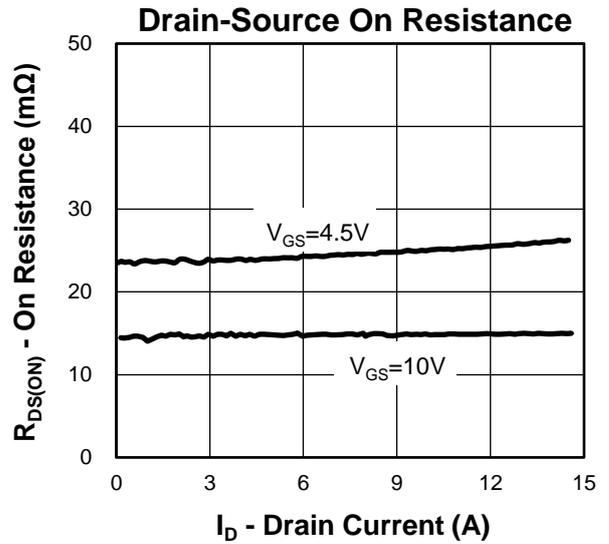
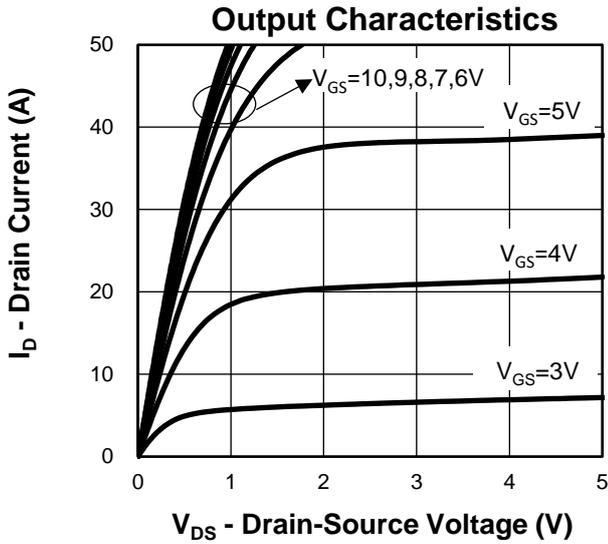
Y =Year,2017-A,2018-B,etc.

M =Month,Jan-1,Feb-2,....Sep-9,Oct-A,Nov-B,Dec-C.

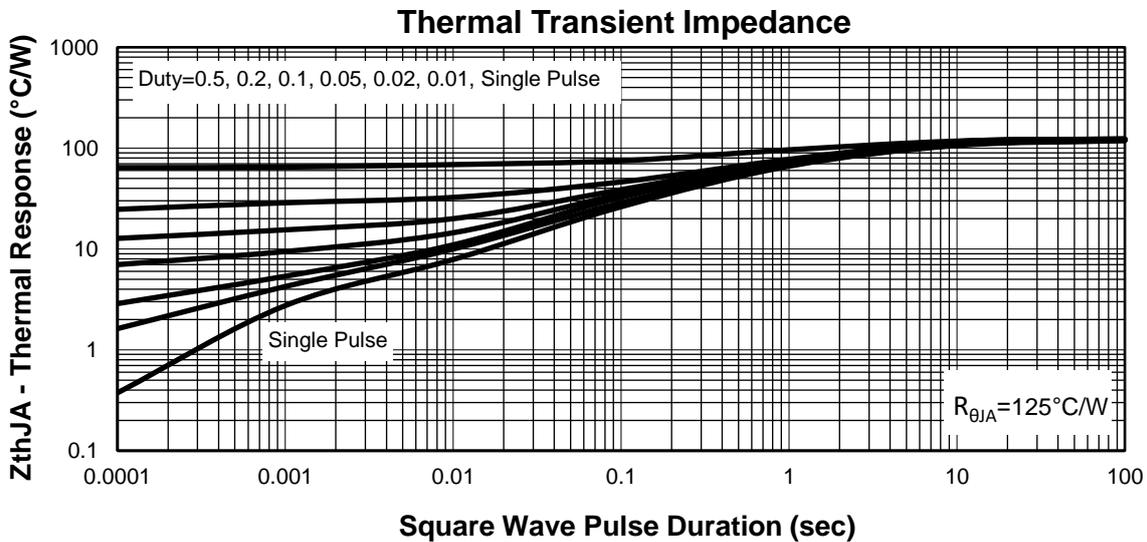
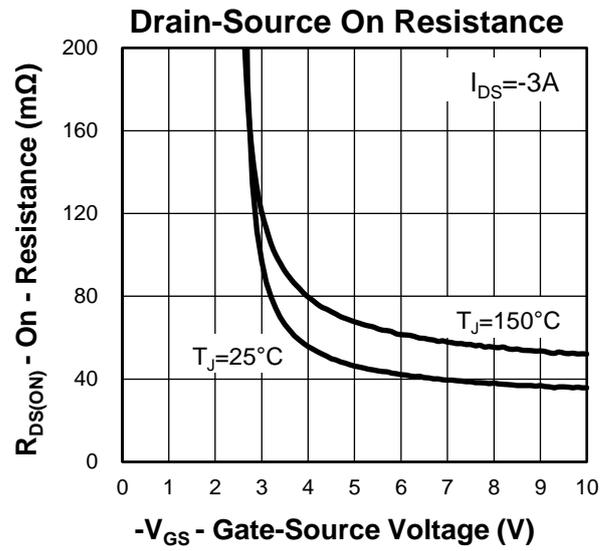
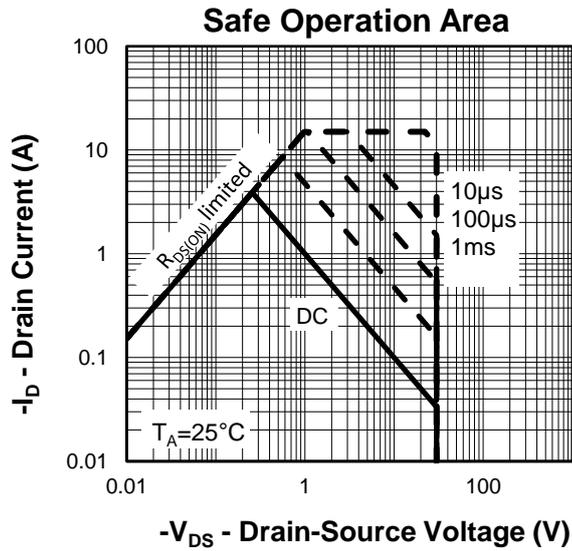
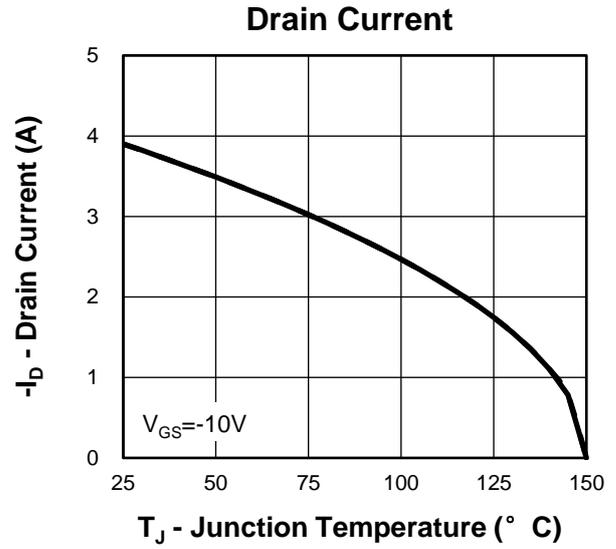
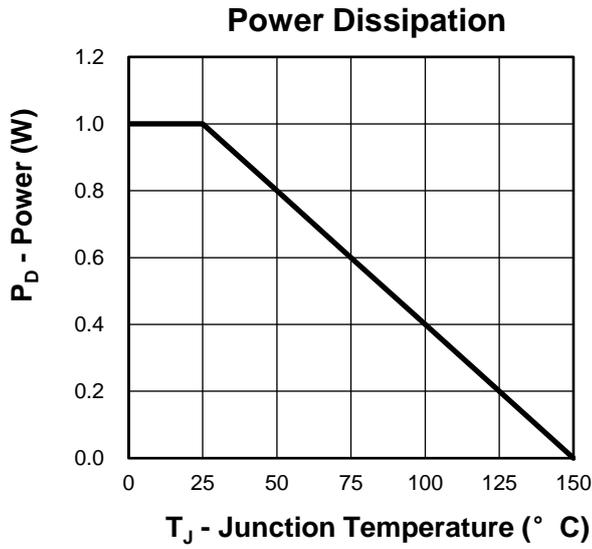
Typical Characteristics(N-Channel)



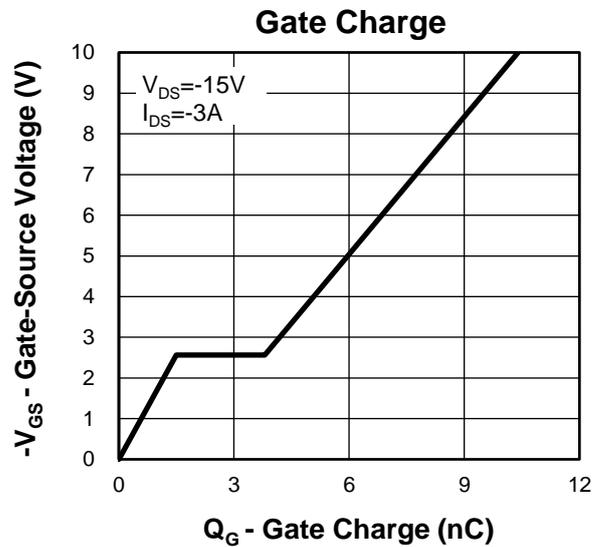
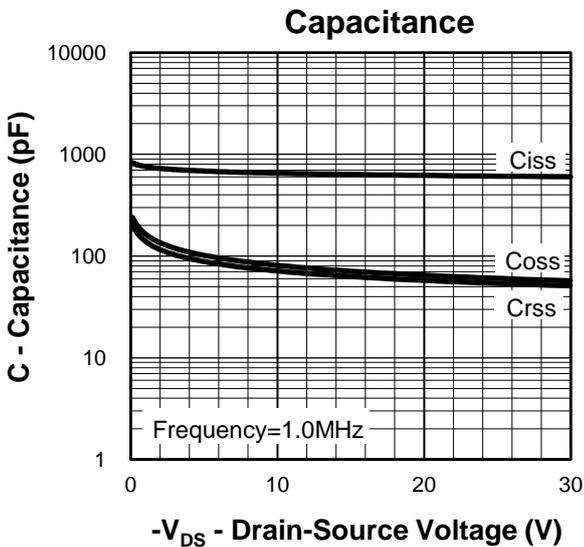
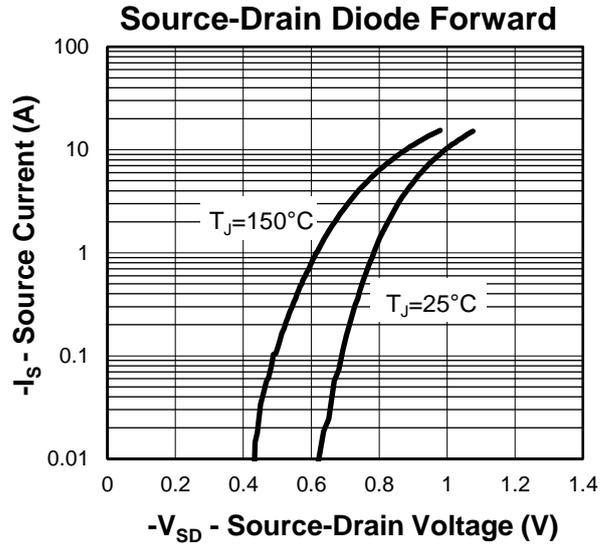
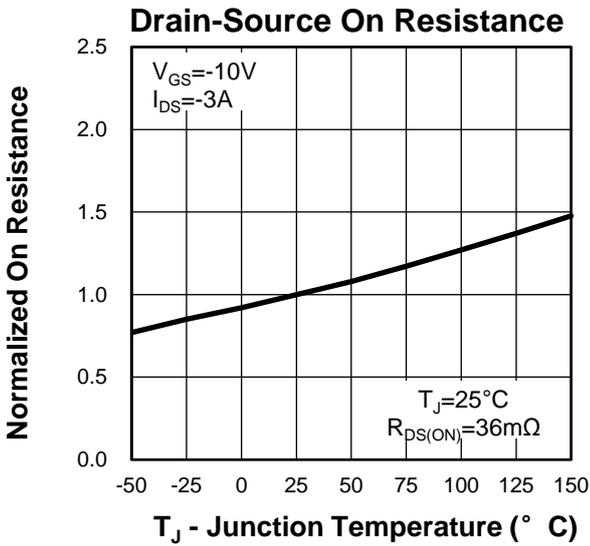
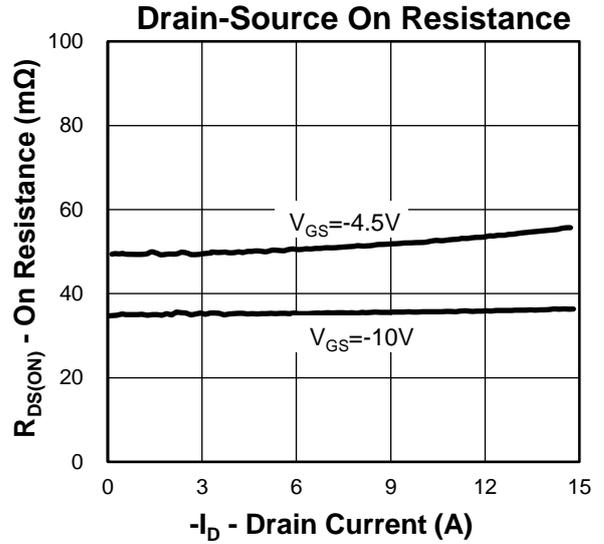
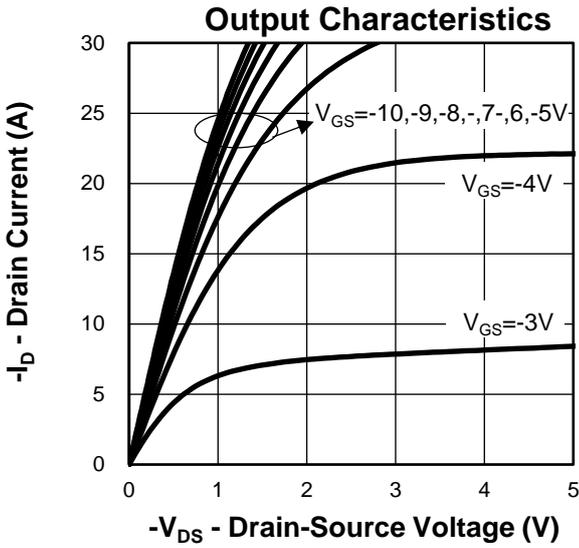
Typical Characteristics(N-Channel)

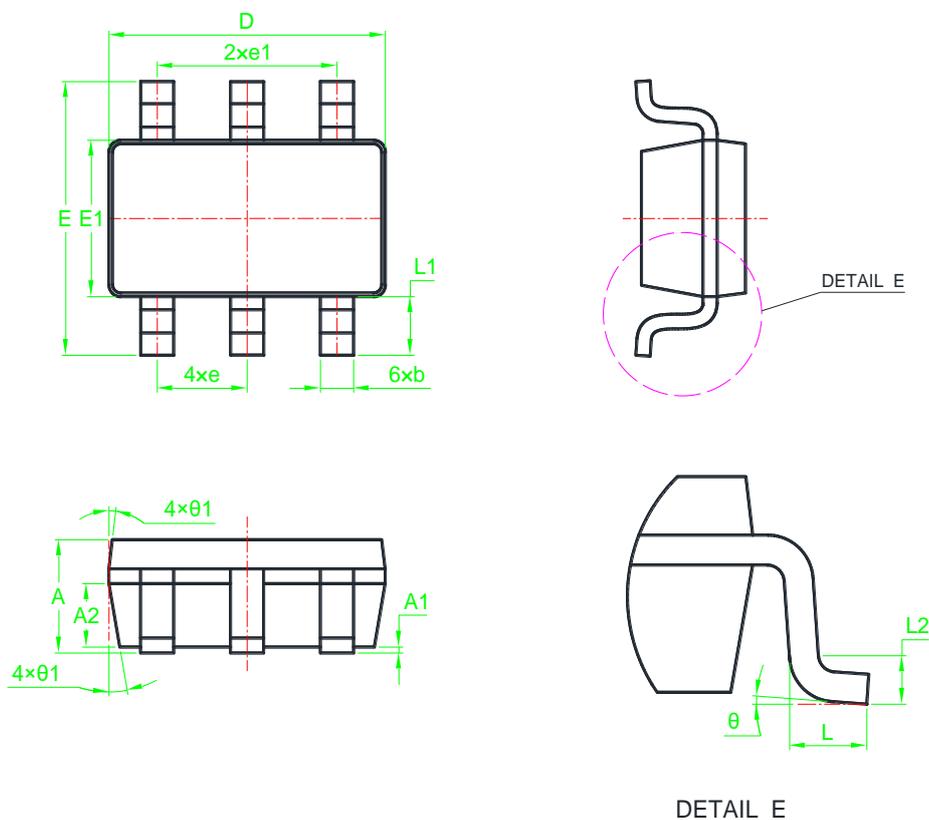


Typical Characteristics(P-Channel)



Typical Characteristics(P-Channel)

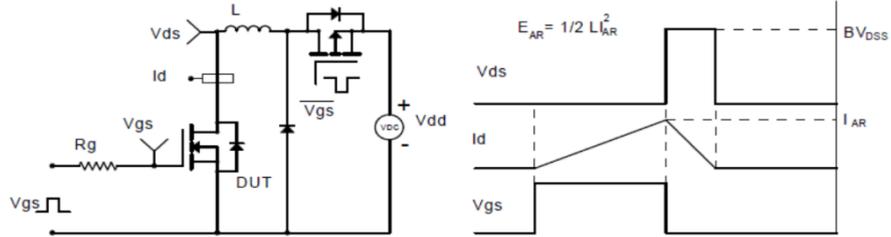


Package Information
SOT23-6L


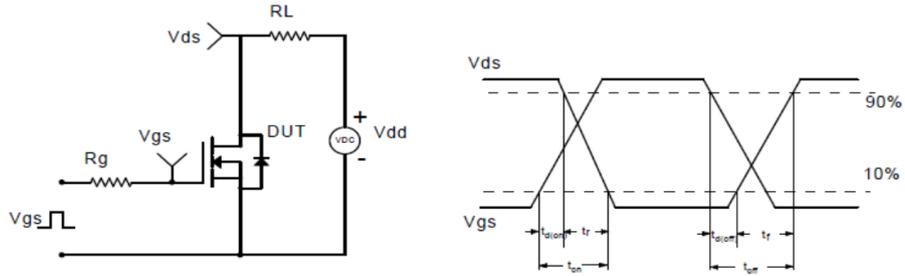
SYMBOL	MM			INCH			SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX		MIN	NOM	MAX	MIN	NOM	MAX
A	1.05	1.15	1.25	0.041	0.045	0.049	e	0.95BSC			0.037BSC		
A1	0.01	*	0.10	0.000	*	0.004	e1	1.9BSC			0.075BSC		
A2	1.05	1.10	1.15	0.041	0.043	0.045	L	0.30	0.45	0.60	0.012	0.018	0.024
b	0.30	0.40	0.50	0.012	0.016	0.020	L1	0.6REF			0.024REF		
D	2.82	2.92	3.02	0.111	0.115	0.119	L2	0.254BSC			0.01BSC		
E	2.65	2.80	2.95	0.104	0.110	0.116	θ	0°	*	8°	0°	*	8°
E1	1.50	1.60	1.70	0.059	0.063	0.067	θ1	0°	*	10°	0°	*	10°

Note: Dimensions do not inclusive burrs and mold flash.

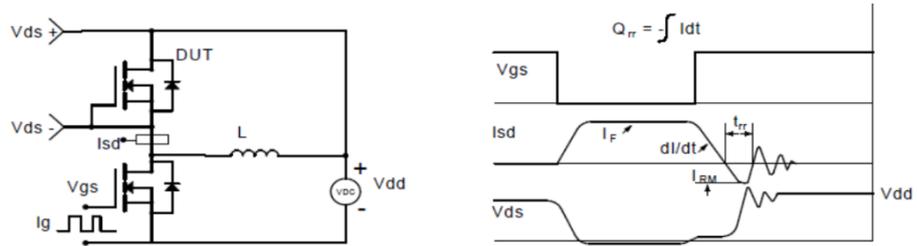
Avalanche Test Circuit and Waveforms(N-Channel)



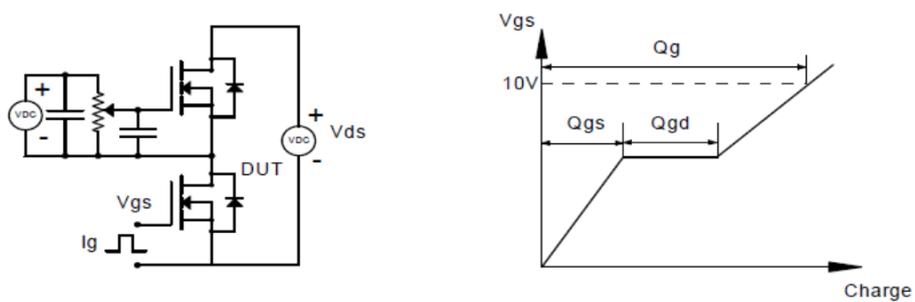
Switching Time Test Circuit and Waveforms(N-Channel)

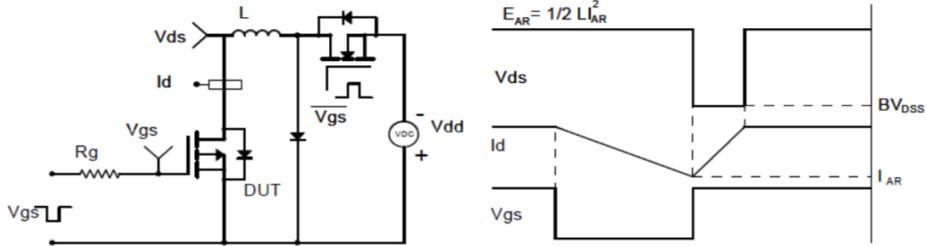
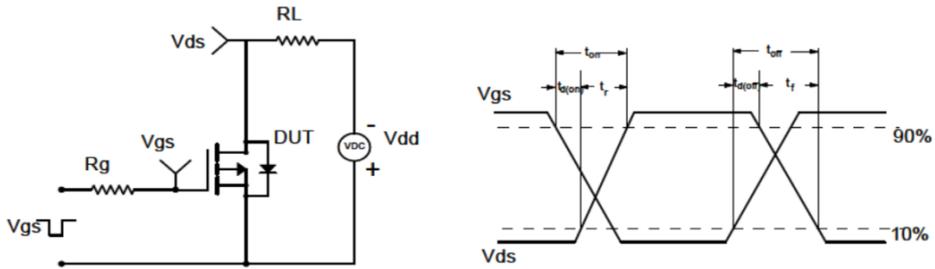
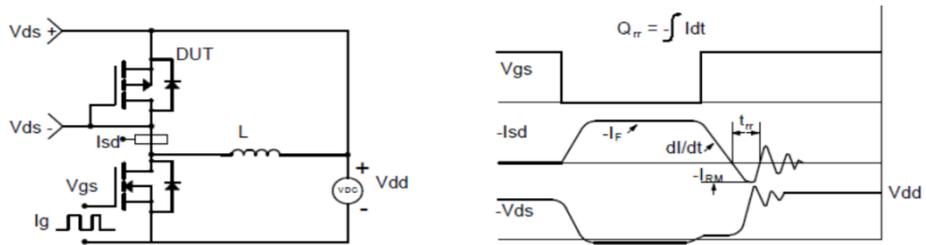
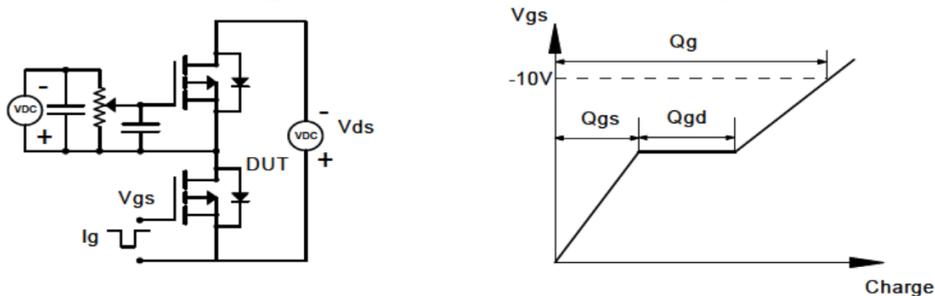


Diode Recovery Test Circuit and Waveforms(N-Channel)



Gate Charge Test Circuit and Waveform(N-Channel)



Avalanche Test Circuit and Waveforms(P-Channel)

Switching Time Test Circuit and Waveforms(P-Channel)

Diode Recovery Test Circuit and Waveforms(P-Channel)

Gate Charge Test Circuit and Waveform(P-Channel)

Customer Service

Kwansemi Semiconductor Co.,Ltd

Email:Sales@kwansemi.com

Web:www.kwansemi.com

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